

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MOLEX JAPAN, LLC	03/22/2023
RECEIVING PARTY DATA	
Name:	MOLEX, LLC
Street Address:	2222 WELLINGTON COURT
City:	LISLE
State/Country:	ILLINOIS
Postal Code:	60532
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17506669
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	Paralegal_koch@CPAGlobal.com
Correspondent Name:	MOLEX, LLC
Address Line 1:	2222 WELLINGTON COURT
Address Line 4:	LISLE, ILLINOIS 60532
ATTORNEY DOCKET NUMBER:	MX-2020-PAT-0078-US-NP
NAME OF SUBMITTER:	CHESHTA BHUTANI
SIGNATURE:	/CHESHTA BHUTANI/
DATE SIGNED:	04/12/2023
Total Attachments: 2	
source=Molex JP Company to Company Assignment_MX-2020-PAT-0078-US-NP.docx#page1.tif	
source=Molex JP Company to Company Assignment_MX-2020-PAT-0078-US-NP.docx#page2.tif	

ASSIGNMENT

WHEREAS, Molex Japan, LLC, a limited liability company having a place of business at 1-5-4 Fukami-Higashi, Yamato, Kanagawa, 242-8585, TW (“Assignor”), owns or owned an interest in an invention entitled “**CONNECTOR ASSEMBLY**”, for which U.S. Patent Application No. **17/506,669** was filed on **October 21, 2021 (MX-2020-PAT-0078-US-NP)**; and

WHEREAS, Molex, LLC, a limited liability company having a place of business at 2222 Wellington Court, Lisle, Illinois 60532 (“Assignee”), desires acquiring or has acquired Assignor’s interest in the above-identified inventions, the Application, and any related U.S. or foreign patent applications and patents;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged:


Assignor hereby authorizes Assignee to file any of the above-referenced patent applications in the name of Assignee, and Assignor authorizes and requests the patent office of any country to issue any patent granted from any of the above-referenced patent applications in the name of Assignee;

Assignor by this Assignment does hereby sell, assign, and transfer, or by virtue of employment or applicable agreements has sold, assigned, and transferred, to Assignee, Assignor’s entire right, title, and interest in and to the above-identified inventions and all improvements and modifications to the above-identified inventions, the Application, any U.S. or foreign patent applications related to the above-identified inventions, any U.S. or foreign patent applications claiming priority to any of the above-referenced patent applications, including any nonprovisional, divisional, continuation, continuation-in-part, reexamination, reissue, extension, substitution, or renewal of any of the above-referenced patent applications, any right to claim priority arising from or required for any of the above-referenced patent applications under any applicable convention, treaty, statute, or regulation, any other right, privilege, or form of protection related to the above-identified inventions or any of the above-referenced patent applications, and any U.S. or foreign patent granted from any of the above-referenced patent applications, to the full end of the term of the patent, to be held and enjoyed by Assignee as fully and entirely as it would have been held and enjoyed by Assignor, including the right to pursue, collect, and retain damages and any other remedies arising from any past, present, or future infringement of patents granted from the above-referenced patent applications;

Assignor hereby warrants and covenants that Assignor has not and will not execute any assignment or other instrument in conflict with this Assignment;

Assignor hereby covenants and agrees to perform any reasonable act that may be necessary or desirable to aid Assignee, its successors, legal representatives, and assigns, to obtain, maintain, and enforce protection in the U.S. and foreign countries for the above-identified inventions, above-referenced patent applications, and patents granted therefrom, including signing lawful papers, executing patent applications, making assignments, rightful oaths, and declarations, and testifying in judicial or administrative proceedings; and

Assignor and Assignee agree that this Assignment may be electronically signed, and that the electronic signatures appearing on this Assignment are the same as handwritten signatures for the purposes of validity, enforceability, and admissibility.

DocuSigned by:

/ _____ /
Jae Hoon Lee, SVP & President, Authorized Signatory on behalf of
Assignor: Molex Japan, LLC
Date: 2023-03-22

DECLARATION OF ACCEPTANCE

Assignee hereby acknowledges and accepts the aforementioned assignment of right, title, and interest and confirms consent that this Assignment may be recorded in appropriate patent offices.

DocuSigned by:

/ _____ /
John J. McKearin, Authorized Signatory on behalf of
Assignee: Molex, LLC
Date: 4/5/2023 | 11:04:19 PM EDT